IRL640

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.18

200

66

9.0

38

Single

 $V_{GS} = 5.0 V$

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL640PbF
Lead (Pb)-free and halogen-free	IRL640PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	200	V	
Gate-source voltage			V _{GS}	± 10	- V	
Continuous drain current	V_{GS} at 5 V $\frac{T_C}{T_C}$	T _C = 25 °C	- I _D	17		
		T _C = 100 °C		11	А	
Pulsed drain current ^a		I _{DM}	68	1		
Linear derating factor			1.0	W/°C		
Single pulse avalanche energy ^b		E _{AS}	580	mJ		
Repetitive avalanche current ^a			I _{AR}	10	А	
Repetitive avalanche energy ^a			E _{AR}	13	mJ	
Maximum power dissipation	T _C = 25 °C		PD	125	W	
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	d For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 3.0 mH, $R_q = 25 \Omega I_{AS} = 17 \text{ A}$ (see fig. 12)

c. $I_{SD} \le 17$ A, dI/dt ≤ 150 A/ms, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

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d. 1.6 mm from case

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	1.0	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$) V, I _D = 250 μΑ	200	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.27	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V$	′ _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-source leakage	I _{GSS}	V	_{GS} = ± 10	-	-	± 100	nA
Zaus ante colta se dusia sumont		V _{DS} = 2	00 V, V _{GS} = 0 V	-	-	25	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	250	μA
Durin an un state un interne	P	$V_{GS} = 5.0 V$	I _D = 10 A ^b	-	-	0.18	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 4.0 V	I _D = 8.5 A ^b	-	-	0.27	Ω
Forward transconductance	g _{fs}		0 V, I _D = 10 A ^b	16	-	-	S
Dynamic					•		
Input capacitance	C _{iss}	V	$V_{cc} = 0 V_{c}$	-	1800	-	
Output capacitance	C _{oss}	$\frac{V_{DS} = 25 \text{ V}}{f = 1.0 \text{ MHz}, \text{ see fig. 5}} - \frac{400}{-120}$		-	pF		
Reverse transfer capacitance	C _{rss}			-			
Total gate charge	Qg			-	-	66	
Gate-source charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 17 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 ^b	-	-	9.0	nC
Gate-drain charge	Q _{gd}		see lig. o and to	-	-	38	1
Turn-on delay time	t _{d(on)}			-	8.0	-	
Rise time	t _r	V _{DD} = 1	00 V, I _D = 17 A	-	83	-	
Turn-off delay time	t _{d(off)}	$R_g = 4.6 \Omega, R_D = 5.7 \Omega$, see fig. 10 b - 44 - 52		-	ns		
Fall time	t _f			-	52	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal source inductance	L _S			-	7.5	-	
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	-	1.2	Ω
Drain-Source Body Diode Characteristic	s					-	
Continuous source-drain diode current	I _S	MOSFET symbo showing the		-	-	17	A
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	68	
Body diode voltage	V _{SD}	T _J = 25 °C, I	_S = 17 A, V _{GS} = 0 V ^b	-	-	2.0	V
Body diode reverse recovery time	t _{rr}	T 05 %0 1	17 A dl/dt 100 A / b	-	310	470	ns
Body diode reverse recovery charge	Q _{rr}	$I_{\rm J} = 25^{-}0, I_{\rm F} =$	17 A, dl/dt = 100 A/µs ^b	-	3.2	4.8	μC
Forward turn-on time	t _{on}	Intrinsic turn	-on time is negligible (turn	-on is do	minated b	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

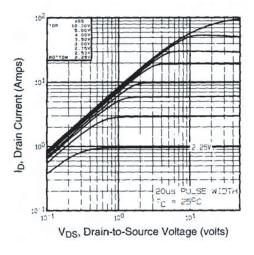


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

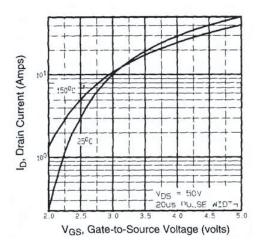


Fig. 3 - Typical Transfer Characteristics

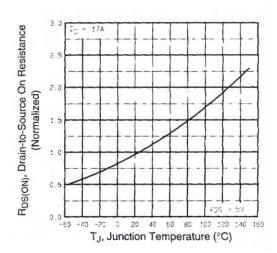


Fig. 4 - Normalized On-Resistance vs. Temperature

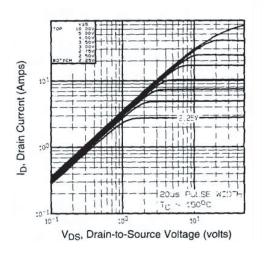
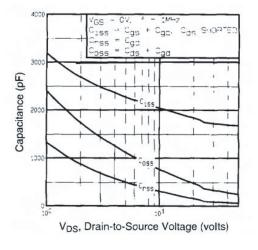
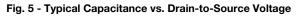


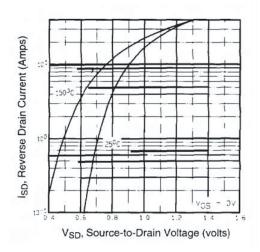
Fig. 2 - Typical Output Characteristics, T_C = 150 °C

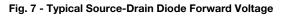
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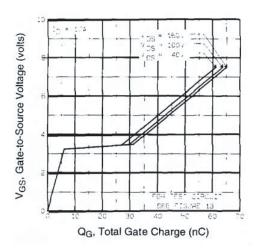


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

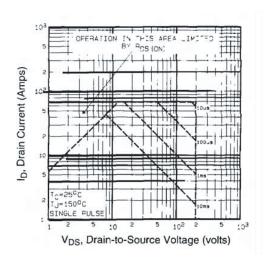


Fig. 8 - Maximum Safe Operating Area

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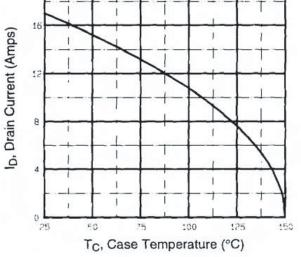


Fig. 9 - Maximum Drain Current vs. Case Temperature

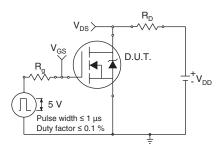


Fig. 10a - Switching Time Test Circuit

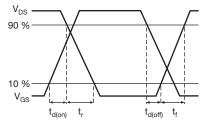
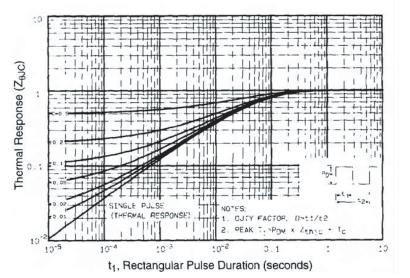


Fig. 10b - Switching Time Waveforms





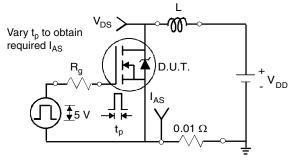


Fig. 12a - Unclamped Inductive Test Circuit

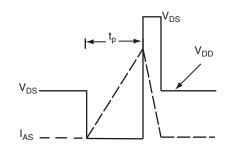


Fig. 12b - Unclamped Inductive Waveforms

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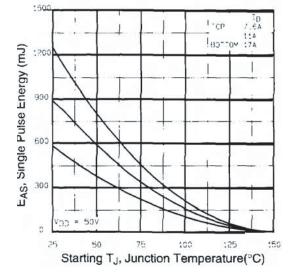


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

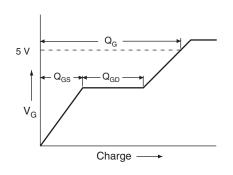


Fig. 13a - Basic Gate Charge Waveform

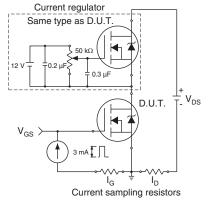


Fig. 13b - Gate Charge Test Circuit

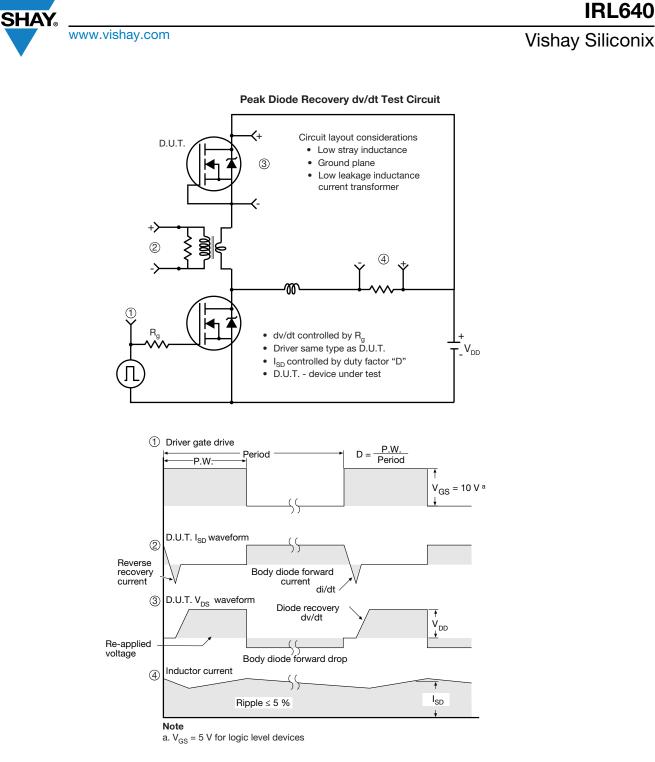


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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